

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN THE MATTER OF: KIM et al  
SERIAL NO: 10/553,647  
FILED: October 14, 2005  
TITLE: RESIN COMPOSITION FOR MOLD USED IN FORMING  
MICROPATTERN, AND...  
GROUP: 4151  
CONFIRMATION NO: 5573  
EXAMINER: Ryan M. Ochylski

**R E S P O N S E**

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

SIR:

This is in response to the outstanding office communication dated April 24, 2009. Applicant respectfully requests that any insufficient fees be deducted from our deposit account 504581.

In the subject application, claims 9-11 have been withdrawn from consideration leaving claims 1-8 as currently pending. The outstanding office communication is a final rejection based upon Audsley et al (USP 4,929,403) which is a new reference not earlier cited. Nevertheless, the following remarks are presented for the Examiner's consideration with the expectation that the final rejection will be withdrawn and the application allowed.